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APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/010,412	10/010,412 12/07/2001		Russel Shirley	AMDA.499C1 (TT4002/03C1)	6042	
40581	7590	07/11/2006		EXAM	EXAMINER	
CRAWFO		NU PLLC DRIVE, SUITE 390	GANDHI, JAY	GANDHI, JAYPRAKASH N		
ST. PAUL, MN 55120				ART UNIT	PAPER NUMBER	
·				2125	2125 DATE MAIL ED: 07/11/2006	
				DATE MAIL ED: 07/11/2004		

Please find below and/or attached an Office communication concerning this application or proceeding.

		A 11 A1 A1	Amplicant(a)				
		Application No.	Applicant(s)				
	Office A Company	10/010,412	SHIRLEY ET AL.				
	Office Action Summary	Examiner	Art Unit				
		Jayprakash N. Gandhi	2125				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
A SHO WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATES as ions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tirr vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status							
•	Responsive to communication(s) filed on <u>24 Ap</u> This action is <b>FINAL</b> . 2b) This	o <u>ril 2006</u> . action is non-final.					
3)	3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Dispositi	on of Claims						
5)□ 6)⊠ 7)□	Claim(s) 14-24 is/are pending in the application 4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed.  Claim(s) 14-24 is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or	vn from consideration.					
Applicati	on Papers						
10)	The specification is objected to by the Examiner The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the o Replacement drawing sheet(s) including the correcti The oath or declaration is objected to by the Example.	epted or b) objected to by the Edrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority u	nder 35 U.S.C. § 119						
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>							
2) Notice 3) Information	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:					

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# Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 14, 16, 17 and 19-23 are rejected under 35 U.S.C. 102(e) as being anticipated by Wiesler et al US Pub 2001/0047222 (*U.S. Provisional Application* 60/199453). The claimed invention reads on Wiesler et al as follows:

Wiesler et al discloses (claim 14) a computer-based automated method for tracking the movement of masks (reticles) used in a wafer processing facility (paragraphs 5, 6, page 5 section 1.1), the masks being moved in mask pods (reticle carriers, paragraphs 5, 6, page 5 table 1-11 "reticle carrier", page 15 section 4.3 lines 1-6), the method comprising for each mask, generating mask data that includes a mask identification code (figure 3A, paragraph 19, table 4-5), using a computer (reference number 204, figure 3-1, page 7 TransNet RMS "server") to process the mask data, including cross-referencing respective mask identification codes to pod identification codes (figure 3A, reticle ID, reticle carrier ID, paragraph 19, claims 3, 4, table 4-5, reticle ID, reticle carrier ID) and updating the mask data to include a facility location identification code (storage of reticle in stocker, figure 3B, current location,

table 4-5 page 28-29 section 4.6), conducting a degradation analysis on each mask that includes a comparison of the mask data to a mask baseline specification so as to generate degradation data for each mask (figure 3B, inspection, figure 3E, inspection results, paragraph 20, page 25 section 4.5.3), and analyzing and tracking the mask degradation data to determine the useful life of each mask (paragraph 20, page 25 section 4.5.3) (claim 16) further including continuously updating the mask data to reflect the new location identification code in response to the mask being routed to a new location (figure 3B, paragraph 19, 20, current location, processing station, paragraph 15, table 4-5, current location, page 16 section 4.3.1 "add or update the additional usage tracking information, page 28-29 section 4.6), (claim 17) wherein conducting a degradation analysis on each mask includes comparing the mask data to desired mask attributes (figure 3B, "inspection", figure 3E inspection results, paragraph 20, figure 3E "Inspection max", "uses between inspections", "clean max", page 25 section 4.5.3), (claim 19) wherein determining the useful life of each mask includes comparing the mask data with a predefined level of mask degradation (paragraph 20. determination of cleaning, repair needs has some inherent predefined level, page 25 section 4.5.3), (claim 20) wherein the useful life of each mask is determined as the mask's movement is tracked (figure 3B, paragraph 19, 20, includes current and last locations, it is clear that the movement is tracked, movement would also be tracked when reticle is sent for the inspections, figure 3B "location inspection", table 4-5, current locations, page 28-29, section 4.6) (claim 21) wherein the determined useful life of each mask is continuously updated as the mask moves throughout the wafer

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processing facility (figure 3B, paragraph 19, 20, includes current and last locations, it is clear that the movement is tracked, considered continuous, *table 4-5*, *current*locations, page 28-29, section), (claim 22) wherein the degradation data includes data corresponding to the effects of cleaning the mask (figure 3E, "clean max", table 4-7) and (claim 23) wherein the degradation data includes data corresponding to the effects of handling the mask (figure 3B, "times inspected", paragraph 19, 20, figure 3C, "repair count", figure 3E "inspection max", "uses between inspections", "uses between cleaning" all related to effects of handling, tables 4-5, 4-7, paragraphs 4.5.5, 4.5.7).

### Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claim15 is rejected under 35 U.S.C. 103(a) as being unpatentable over Wiesler et al US Pub 2001/0047222 (*U.S. Provisional Application 60/199453*) in view of Terao (U.S. Pat 5,191,535).

Wiesler et al teaches most all of the instant invention as applied to claim 14 above, Wiesler et al fails to teach including tracking an event associated with a select wafer lot, the event tracking including matching the mask identification code with the select wafer lot.

Terao teaches using the computer to track an event associated with a mask (reticle is functionally same as a mask) and a wafer lot to an event on a processing line (abstract, col. 1 lines 32-55, "previous step").

Wiesler et al and Terao are analogous art because they are both directed to a reticle or mask handling systems.

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to utilize the matching of reticles to wafer lots of Terao in the reticle management system of Wiesler et al because Terao teaches that the identification of a "to be processed lot" and mask prior to processing by a production unit reduces standing time of the production unit, therefore reducing overall production time (col. 3 lines 5-12), using a computer control system is also known and taught to provide faster processing of mask data, which was previously done manually (col. 1 lines 10-20), these reasons provide adequate motivation to combine the teachings of these references.

Claim 18 is rejected under 35 U.S.C. 103(a) as being unpatentable over Wiesler et al US Pub 2001/0047222 (*U.S. Provisional Application 60/199453*) in view of Wang et al (U.S. Pat 5,859,964).

Wiesler et al teaches most all of the instant invention as applied to claim 14 above, Wiesler et al fails to teach modeling the mask degradation.

Wang et al teaches a system and method for performing real time data acquisition, process modeling and fault detection of a wafer fabrication process (abstract, title, all)

Wiesler et al and Wang et al are analogous art because they are both directed to wafer fabrication.

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made utilize the modeling and fault detection of Wang et al in the reticle management system of Wiesler et al because Wang et al teaches a fault detector that uses process event information in combination with the process parameter signal samples to perform improved fault detection (col. 3 lines 21-30) and the present invention collects both process event information generated by the process equipment and process parameter data without reliance on the process equipment, the system advantageously acquires the process parameter data at a constant and relatively high sampling rate (col. 6 lines 29-34, also pertinent to instant application claim 21).

Claim 24 is rejected under 35 U.S.C. 103(a) as being unpatentable over Wiesler et al US Pub 2001/0047222 (*U.S. Provisional Application 60/199453*) in view of DeWitt (U.S. Pat 5,214,486).

Wiesler et al teaches most all of the instant invention as applied to claim 14 above, Wiesler et al fails to teach wherein the degradation data includes data corresponding to the effects of particle contamination of the mask.

DeWitt teaches degradation data includes data corresponding to the effects of particle contamination of the mask (abstract, col. 1 lines 7-10, col. 5 lines 52-60, claim 12).

Wiesler et al and Wang et al are analogous art because they are both directed to wafer fabrication.

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was use the data corresponding to particle contamination of the mask of DeWitt in the reticle management system of Wiesler et al because DeWitt teaches that as the mask and reticle designs continue to evolve in complexity and resolution, the detection of submicron contaminants on a photo mask becomes critically important, the high reliability requirement of the integrated circuits (ICs) demands very stringent quality assurance criteria to produce and use absolute defect-free masks and a single particle in a mask can cause manufacturing defects and render a sequence of very costly, thus it places great importance to detect and remove any contamination or particle from the mask before the IC manufacturing process begins (col. 1 lines 12-30).

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## Response to Arguments

1. Applicant's arguments filed 04/24/06 have been fully considered but they are not persuasive.

Applicant argues that the office action fails to teaches a comparison of the of the mask data to a mask baseline specification. Examiner would like to point out that while this is disclosed in the specification, the claims are silent on "baseline specification".

Applicant argues that '222 appears to be directed to reticle history and not forecasting. Again claims are silent on forecasting which they do determine a useful life of each mask, this is considered different then forecasting. As a reminder, the data of Wiesler et al includes "clean max", figure 3E, which is the maximum number of times the reticle can be cleaned and also "Times cleaned" figure 3A which both provide an indication of a useful life indication.

#### Conclusion

3. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jayprakash N. Gandhi whose telephone number is 571-272-3740. The examiner can normally be reached on 7:00 - 4:30 (Mon. - Fri.).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Leo P. Picard can be reached on 571-272-3749. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Jayprakash N Gandhi Primary Examiner Art Unit 2125